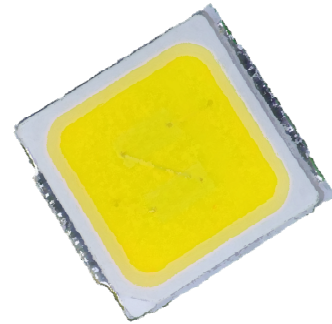


## 3030A06-XXH10-2S2P-T10-LX

## Datasheet

This 3030 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc.

This part has a foot print that is compatible to most of the same size LED in the market today.



### FEATURES

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- Available in Cool White, Neutral White and Warm White color
- ANSI-compatible chromaticity bins
- High luminous Intensity and high efficiency
- Compatible with reflow soldering process
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- Silicone encapsulation
- Environmental friendly, RoHS compliance

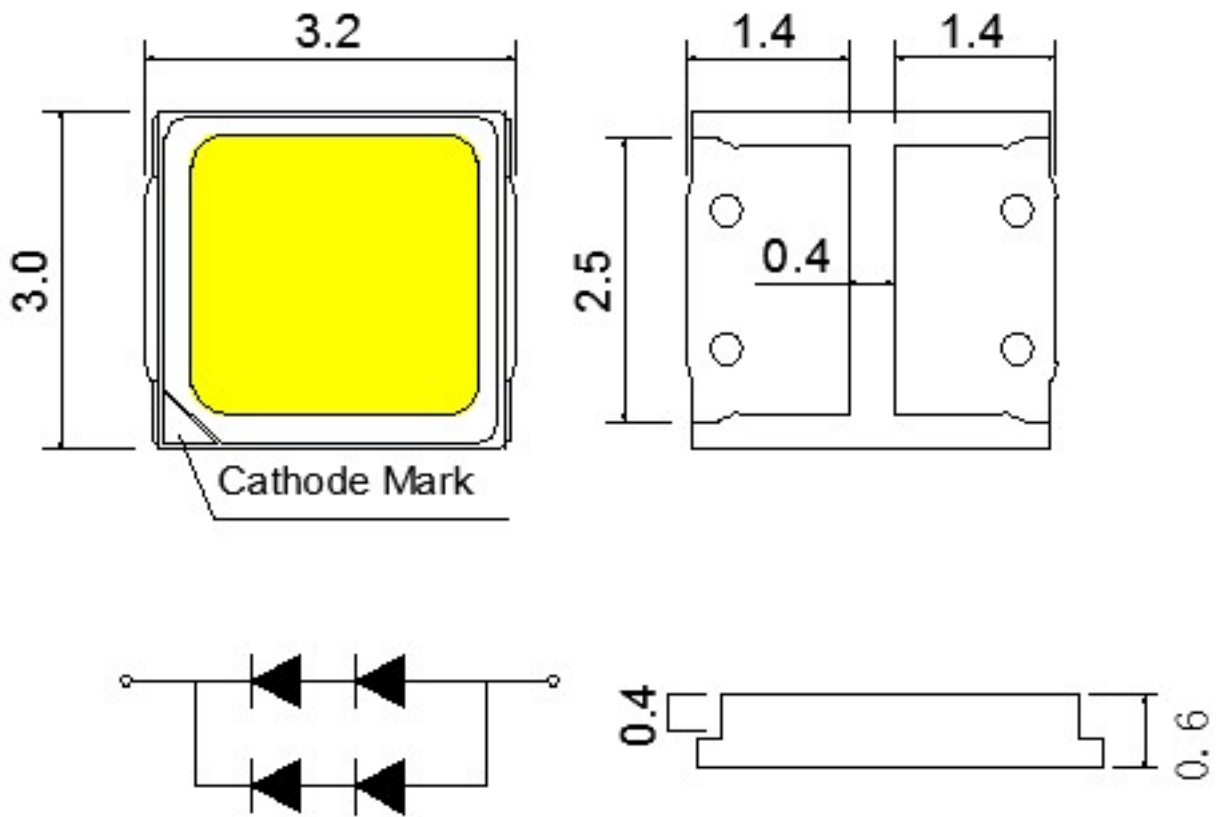
### APPLICATIONS

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- Flat panel light
- Backlighting
- Downlight
- Signage and channel letter
- Reading lamp
- Courtyard light
- High bay light

Note: The information in this document is subject to change without notice.

## PACKAGE DIMENSIONS



Notes:

1. All dimensions in millimeters.
2. Thickness tolerance of copper plate is  $\pm 0.02\text{mm}$ .
3. Thickness tolerance of product is  $\pm 0.05\text{mm}$ .
4. Tolerance is  $\pm 0.1\text{mm}$  unless otherwise noted.

## ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Absolute Maximum Rating	Unit
Forward current	$I_F$	400	mA
Peak Forward Current <sup>[1]</sup>	$I_{FP}$	500	mA
Reverse Voltage	$V_R$	8	V
Power Dissipation	$P_d$	2000	mW
Operating Temperature	$T_{opr}$	-40~+85	°C
Storage Temperature	$T_{stg}$	-40~+100	°C
Soldering Temperature	$T_{sld}$	Reflow Soldering: 260°C for 10 seconds	
LED Junction Temperature	$T_j$	115	°C

Note:

$I_{FP}$  Conditions: Pulse Width  $\leq 10$ msec. and Duty  $\leq 1/10$ .

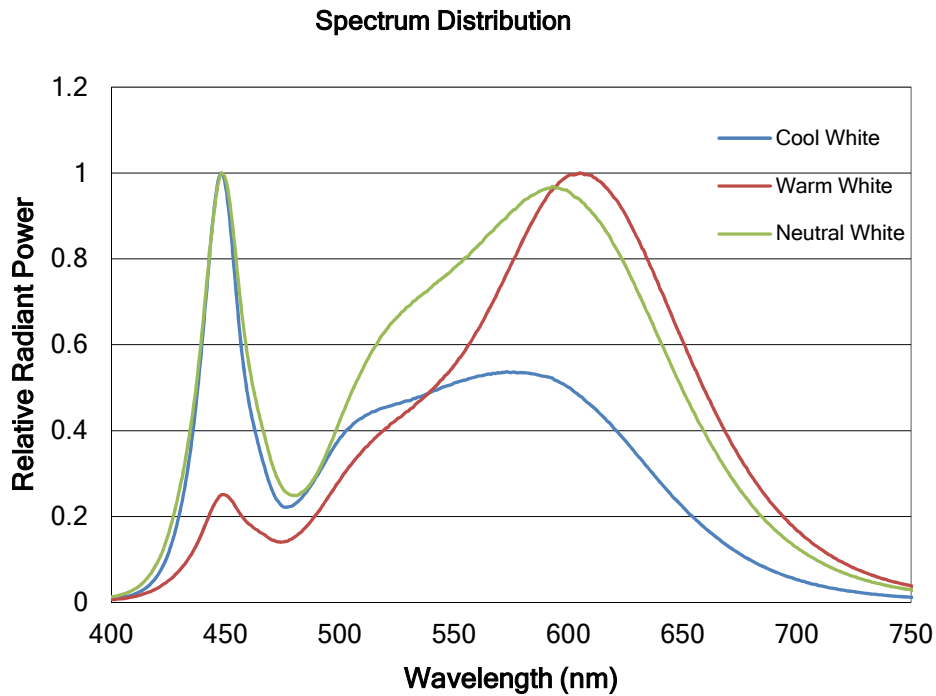
## CHARACTERISTICS (T<sub>j</sub>=25°C)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage <sup>[1]</sup>	$V_F$	$I_F=150$ mA	5.4	--	6.0	V
Viewing Angle	$2\theta_{1/2}$	$I_F=150$ mA	--	120	--	deg.
Luminous Flux	$\Phi_v$	$I_F=150$ mA	120	--	160	lm
Color Rendering Index	CRI	$I_F=150$ mA	80	--	--	--
Color Temperature	CCT	$I_F=150$ mA	2100	--	7000	K
Thermal Resistance (Junction to Solder Point)	$R_{th-js}$	$I_F=150$ mA	--	12	--	°C/W

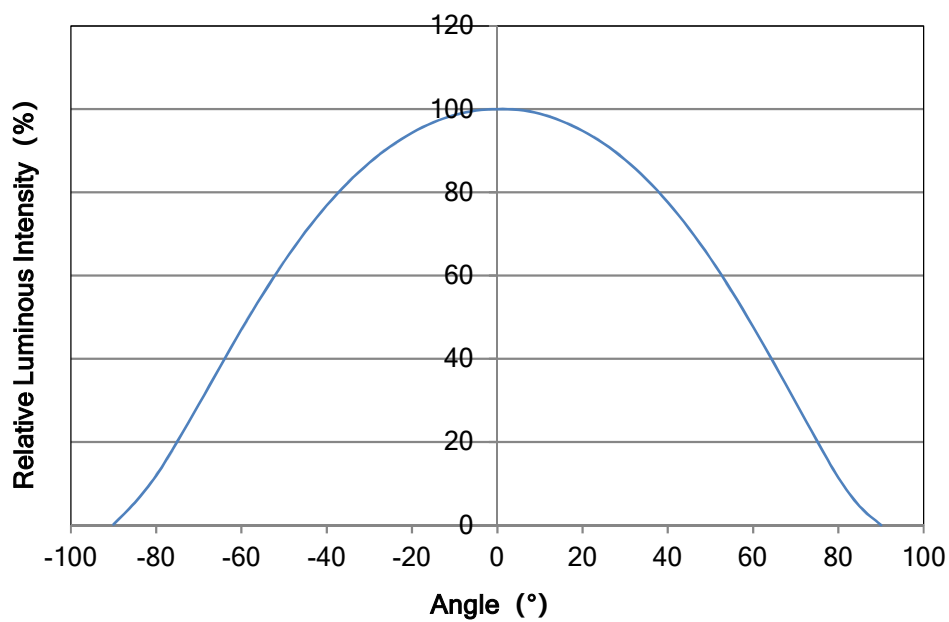
Notes:

- Luminous flux is measured with an accuracy of  $\pm 10\%$ .
- Chromaticity coordinate bins are measured with an accuracy of  $\pm 0.01$ .
- CRI is measured with an accuracy of  $\pm 2$  ;
- Some color and CRI bins may have limited availability, please contact us before ordering.
- All measurements were made under the standardized environment of Shineon

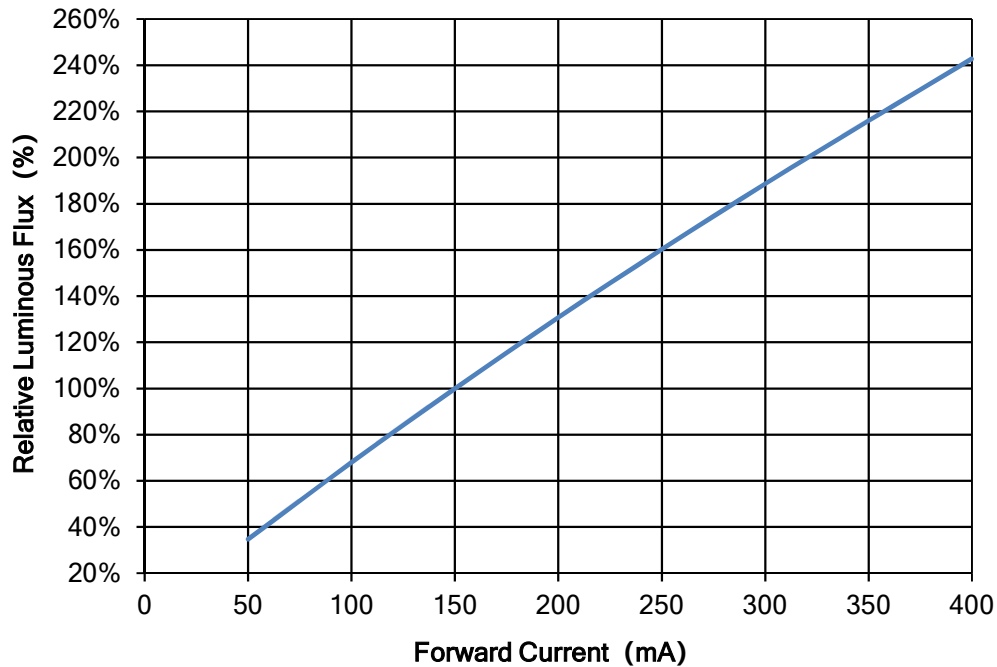
## RELATIVE SPECTRAL POWER DISTRIBUTION ( $T_j=25^\circ\text{C}$ )



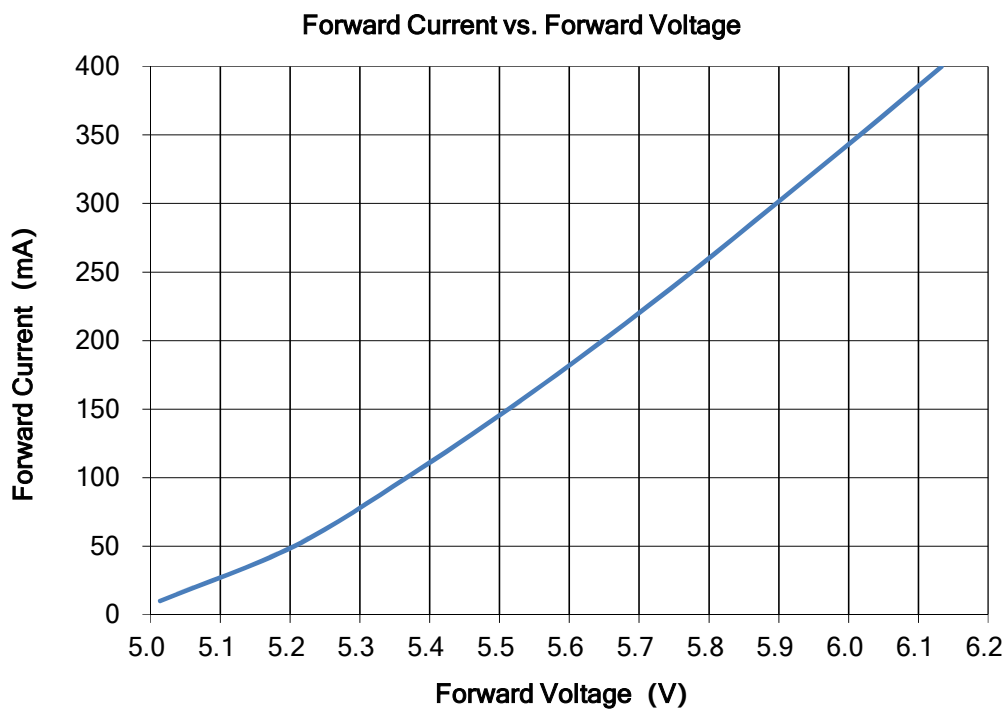
## TYPICAL SPATIAL DISTRIBUTION



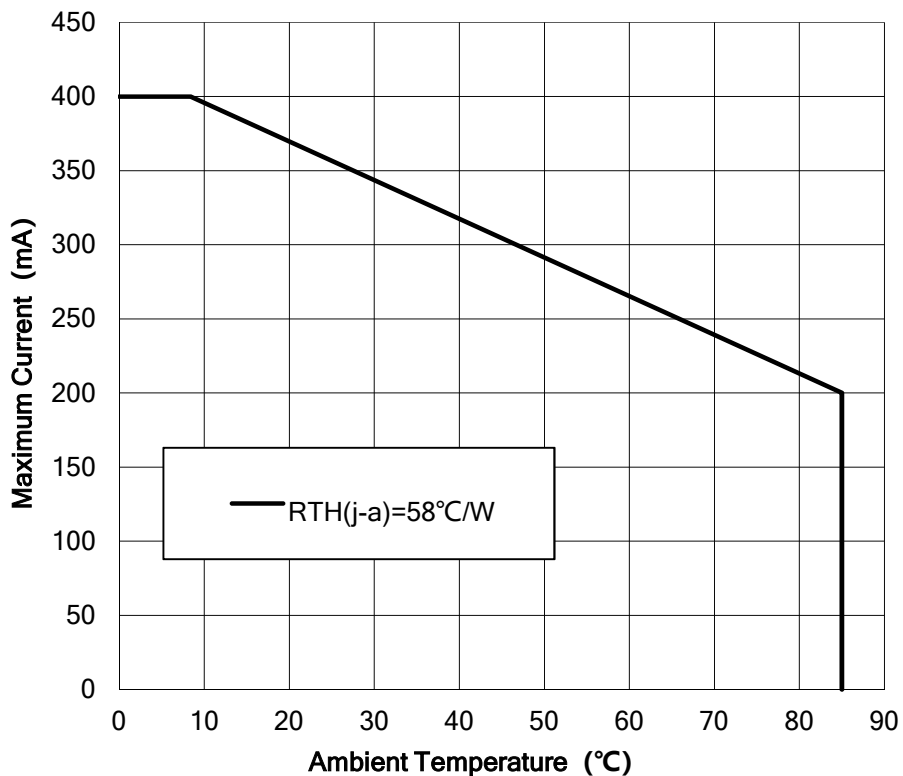
## RELATIVE LUMINOUS FLUX VS. CURRENT ( $T_j=25^\circ\text{C}$ )



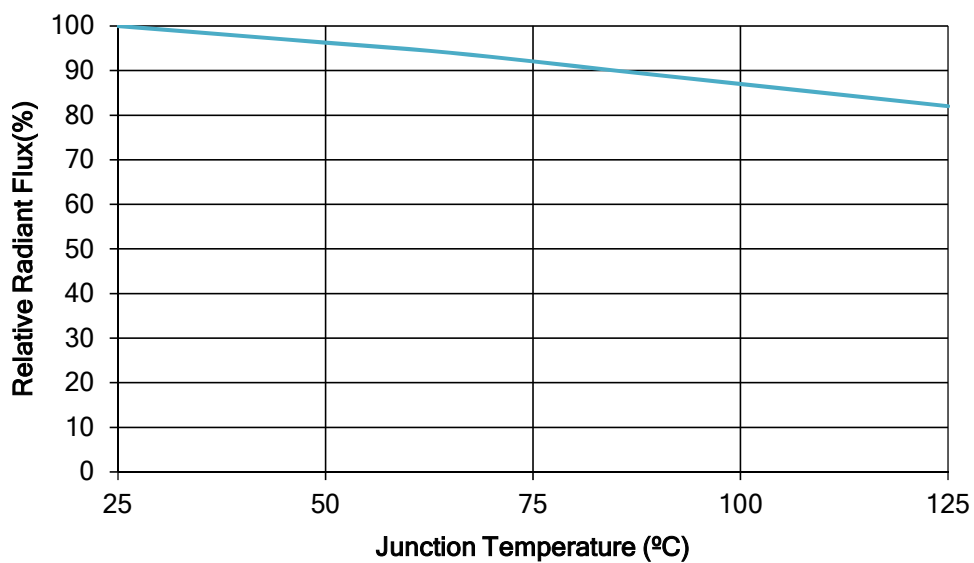
## ELECTRICAL CHARACTERISTICS ( $T_j=25^\circ\text{C}$ )



## MAXIMUM CURRENT VS. AMBIENT TEMPERATURE



## RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE



## SORTING RANKS

### (1) Luminous Flux (T<sub>j</sub>=25°C)

Part Number	Condition	Rank	Unit
3030A06-22H10-2S2P-T10-LX	150mA	Q2	lm
		120-130	
3030A06-27H10-2S2P-T10-LX		Q33	
		135-145	
3030A06-30H10-2S2P-T10-LX		Q43	
		145-155	
3030A06-40H10-2S2P-T10-LX		Q53	
		155-165	
3030A06-50H10-2S2P-T10-LX		Q53	
		155-165	
3030A06-57H10-2S2P-T10-LX		Q53	
		155-165	
3030A06-65H10-2S2P-T10-LX	Q5		
	150-160		

### (2) Forward Voltage (T<sub>j</sub>=25°C)

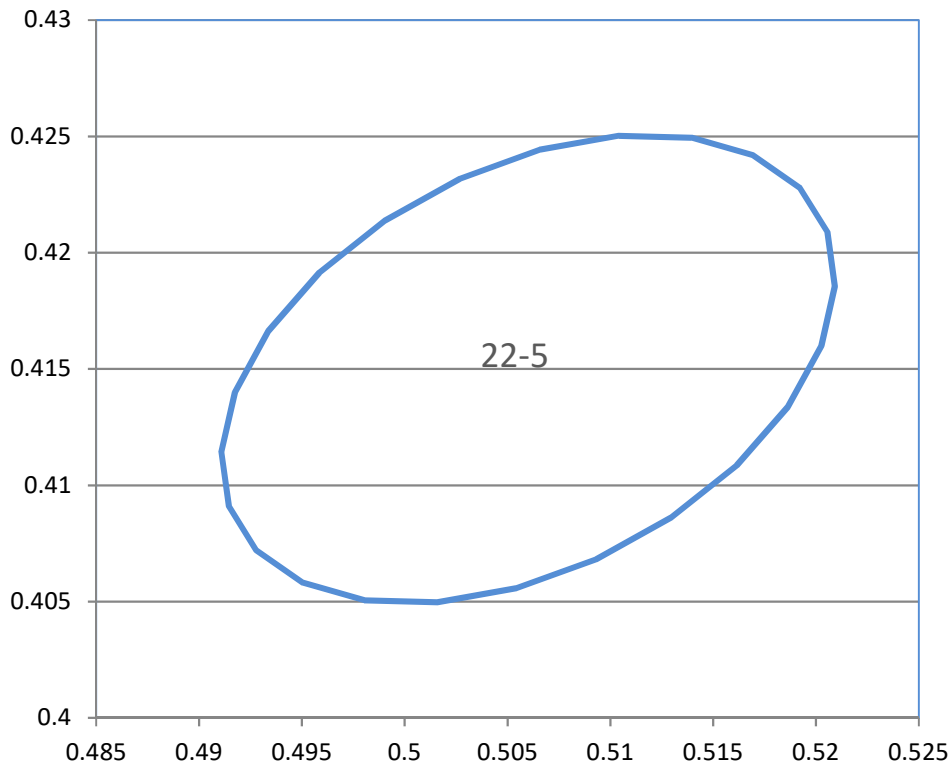
Rank	Condition	Min.	Max.	Unit
C7	150mA	5.4	5.6	V
C8		5.6	5.8	
C9		5.8	6.0	

Notes:

1. 10% tolerance for luminous intensity may be caused by measurement inaccuracy.
2. Measurement Uncertainty of the Forward Voltage : ± 0.06V

## (3) Chromaticity Bins

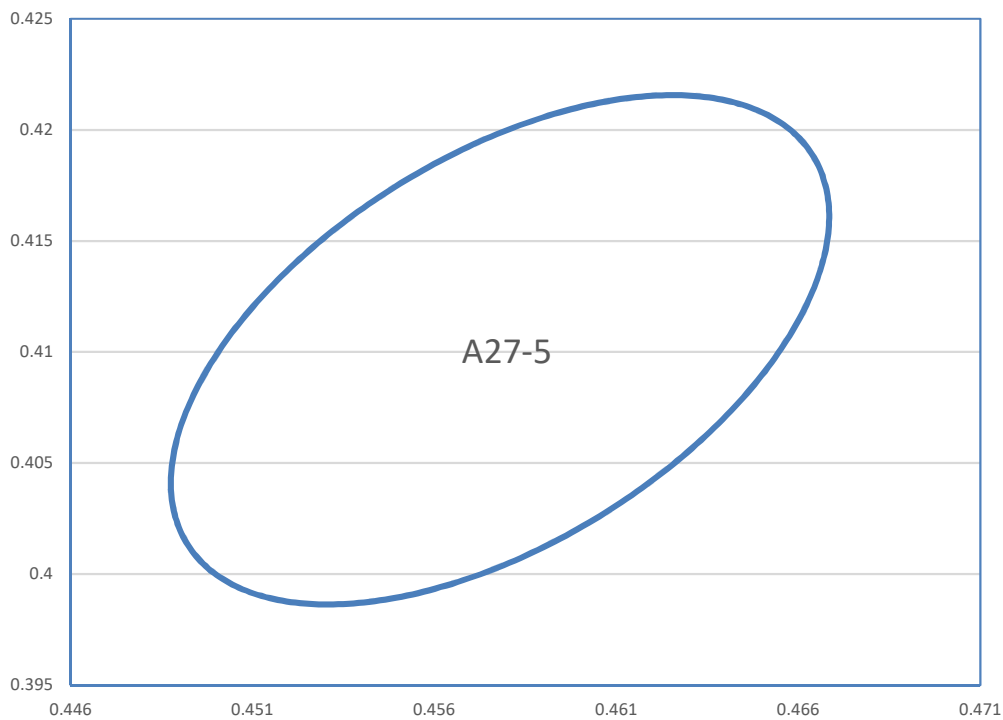
Part Number	3030A06-22H10-2S2P-T10-LX			CCT	2200K
Bin Code	Color Coordinates (X,Y)				
22-5	x	y	a	b	Theta°
		0.506	0.415	0.01177	0.00663



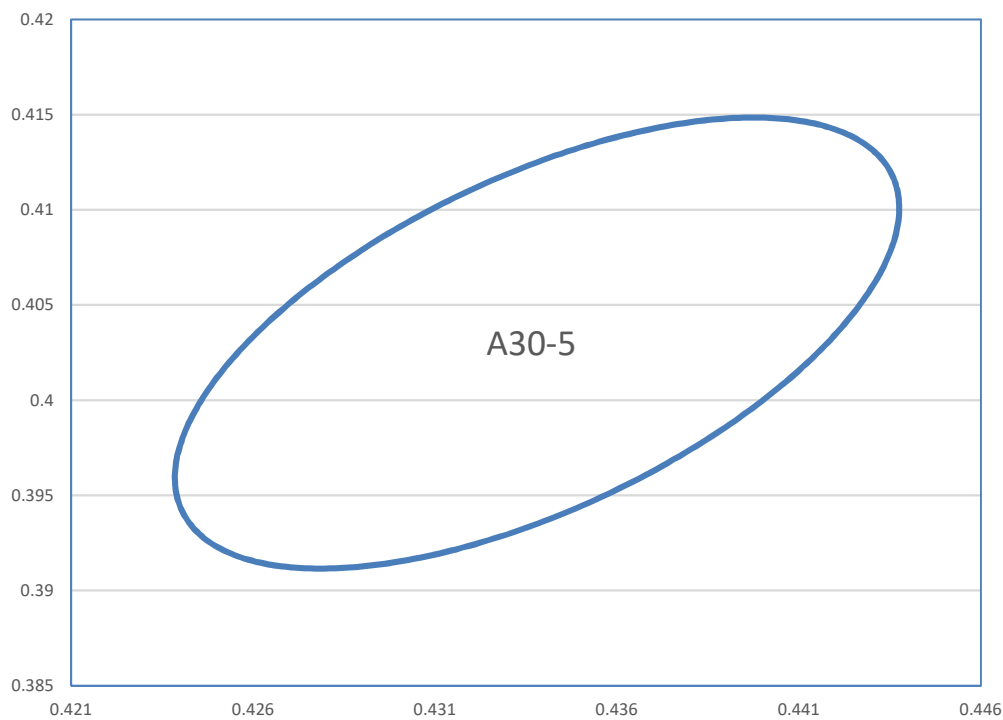


## (3) Chromaticity Bins

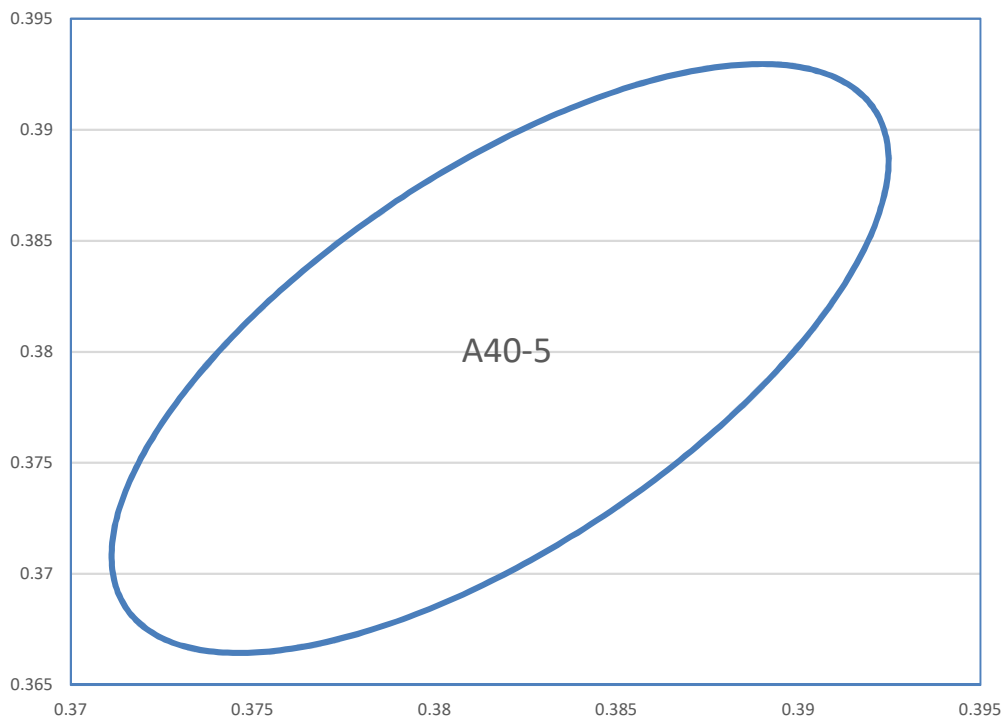
Part Number	3030A06-27H10-2S2P-T10-LX			CCT	2700K
Bin Code	Color Coordinates (X,Y)				
A27-5	x	y	a	b	Theta°
	0.4578	0.4101	0.0135	0.007	53.7



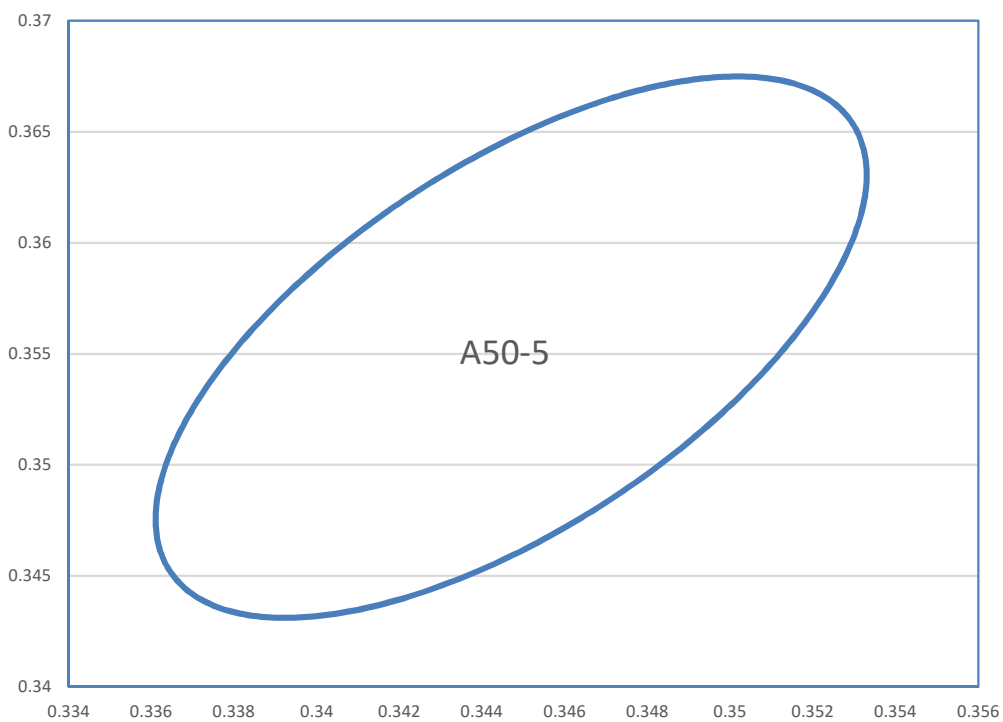
Part Number	3030A06-30H10-2S2P-T10-LX			CCT	3000K
Bin Code	Color Coordinates (X,Y)				
A30-5	x	y	a	b	Theta°
	0.4338	0.403	0.01390	0.00680	53.22



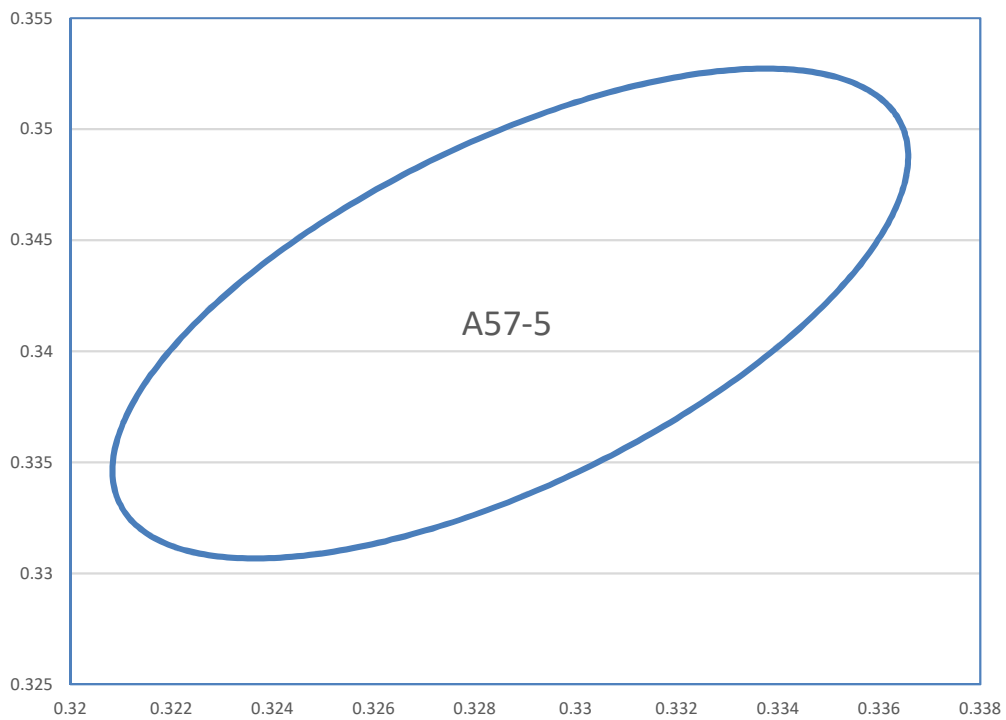
Part Number	3030A06-40H10-2S2P-T10-LX			CCT	4000K
Bin Code	Color Coordinates (X,Y)				
A40-5	x	y	a	b	Theta°
	0.3818	0.3797	0.01565	0.00670	53.72



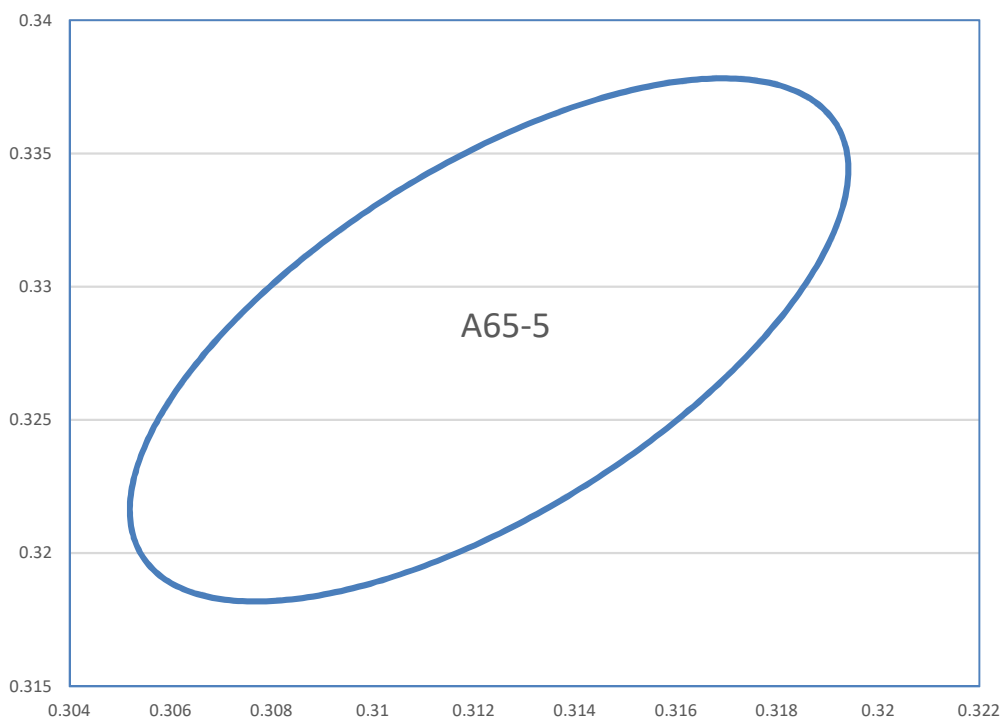
Part Number	3030A06-50H10-2S2P-T10-LX	CCT	5000K		
Bin Code	Color Coordinates (X,Y)				
A50-5	x	y	a	b	Theta°
	0.3447	0.3553	0.01370	0.00590	59.617



Part Number	3030A06-57H10-2S2P-T10-LX			CCT	5700K
Bin Code	Color Coordinates (X,Y)				
A57-5	x	y	a	b	Theta°
	0.3287	0.3417	0.01245	0.00535	59.09



Part Number	3030A06-65H10-2S2P-T10-LX			CCT	6500K
Bin Code	Color Coordinates (X,Y)				
A65-5	x	y	a	b	Theta°
	0.3123	0.3282	0.01115	0.00475	58.57



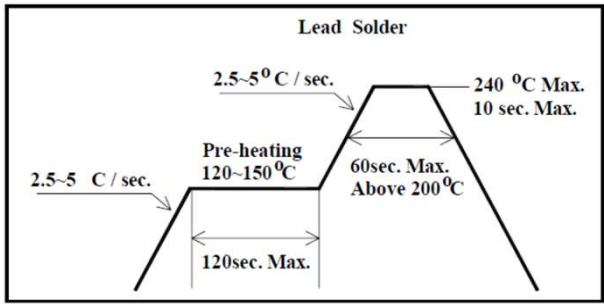
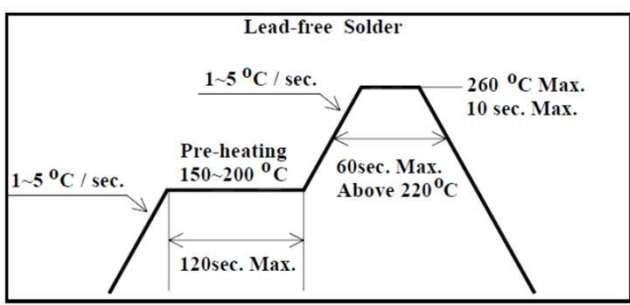
## REFLOW SOLDERING CHARACTERISTICS

### For Reflow Process:

Preheating : 140°C~160°C±5°C, within 2 minutes.  
 Operation heating : 260°C(Max.) within 10 seconds.(Max)  
 Gradual Cooling (Avoid quenching).

Lead solder		Lead-free solder	
Pre-heat	120-150°C	Pre-heat	150-200°C
Pre-heat time	120 sec.Max.	Pre-heat time	120 sec.Max.
Peak Temperature	240°C Max.	Peak Temperature	260°C Max.
Soldering time condition	10 sec.Max.	Soldering time condition	10 sec.Max.

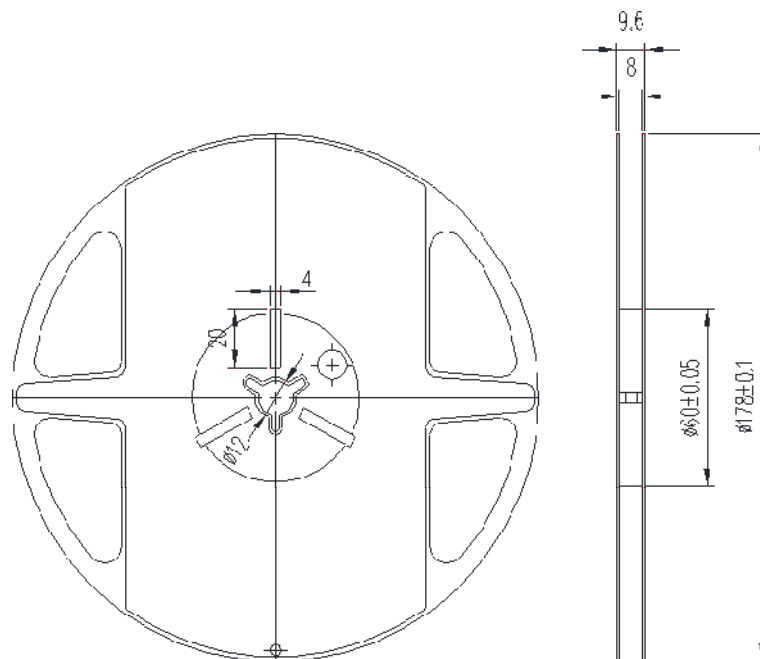
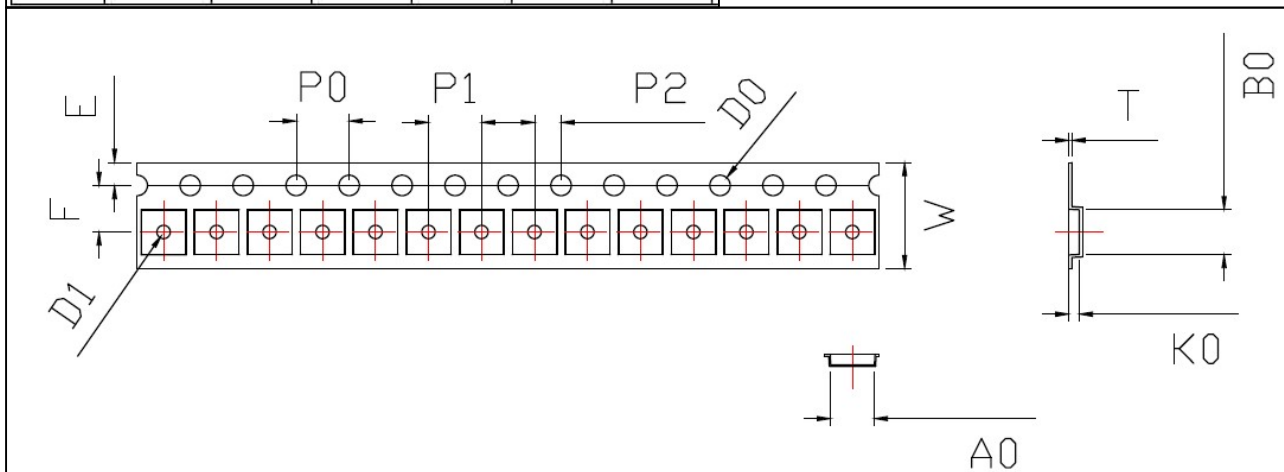
 <p><b>Lead Solder</b></p> <p>2.5~5 °C / sec. (initial ramp)          2.5~5 °C / sec. (pre-heat ramp)          Pre-heating 120~150°C (120sec. Max.)          240 °C Max. (10 sec. Max.)          60sec. Max. Above 200°C</p>	 <p><b>Lead-free Solder</b></p> <p>1~5 °C / sec. (initial ramp)          1~5 °C / sec. (pre-heat ramp)          Pre-heating 150~200 °C (120sec. Max.)          260 °C Max. (10 sec. Max.)          60sec. Max. Above 220°C</p>
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### Notes:

The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

## TAPE AND REEL

symbol	AO	BO	KO	PO	P1	P2
Spec	3.30±0.10	3.30±0.10	1.05±0.1	4.00±0.10	4.00±0.10	2.0±0.1
symbol	W	T	E	F	DO	D1
Spec	8.0±0.2	0.20±0.05	1.75±0.10	3.5±0.05	1.50+0.1/-0	1.1±0.1



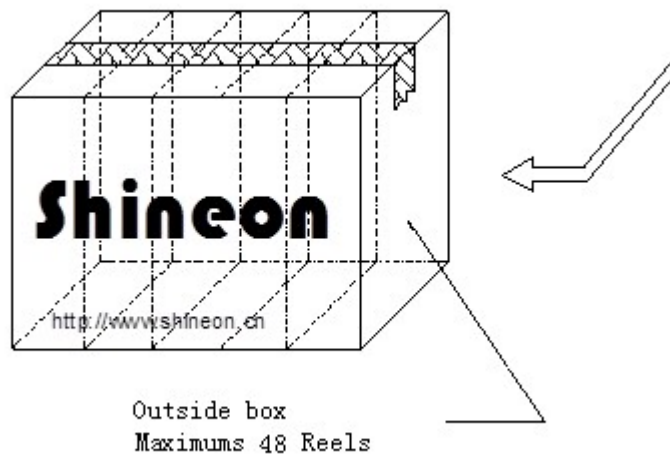
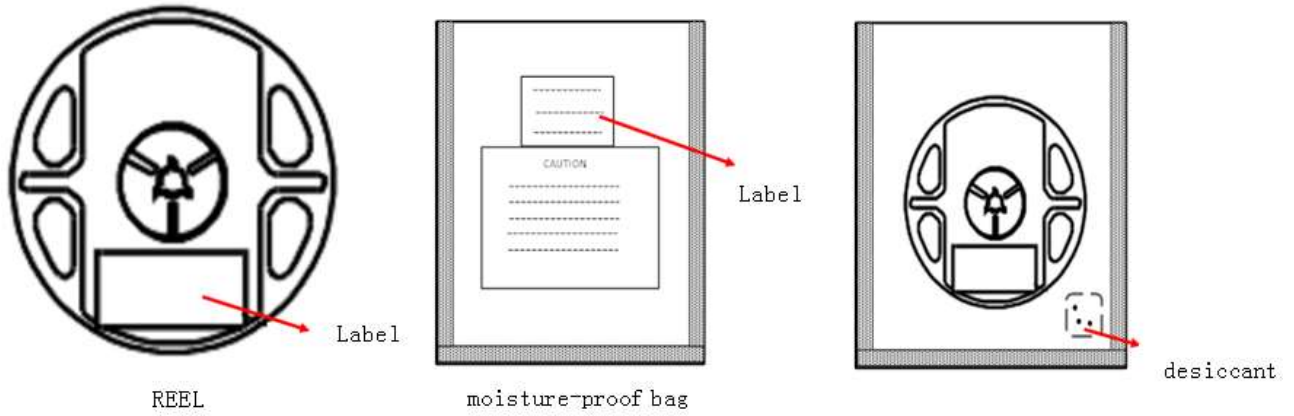
Note: The tolerances unless mentioned is  $\pm 0.1\text{mm}$ , Unit=mm

### Notes:

- (1) Quantity : 4,000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2\text{mm}$
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of  $10^\circ$  to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.



**PACKAGING**



**Reliability Test Items**

Test Items	Test Duration	Number of Damaged
Steady State Operating Life of High Temperature (HTOL) $T_s=85^{\circ}\text{C}$ , $I_F=\text{Max}$	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) $T_a=-40^{\circ}\text{C}$ , $I_F=\text{Max}$	1000hrs	0/20
High Temperature Storage (HTS) $100^{\circ}\text{C}$	1000hrs	0/20
Low Temperature Storage (LTS) $-40^{\circ}\text{C}$	1000hrs	0/20
Thermal Shock (TS) $-45^{\circ}\text{C}\sim 125^{\circ}\text{C}$ 15min dwell 30sec transfer	100cycles	0/20
Solder Resistance (SR) $265^{\circ}\text{C}$ , 3X MSL	5sec	0/20
Solder Ability (SA) $245^{\circ}\text{C}$ 5sec, 95% coverage	5sec	0/11
Mechanical Shock (MS) 1500G 0.5msec pulse shock	Each 6 axis	0/6
Random Vibration (RV) 6G RMS, 10-2000Hz, 10min	Per axis	0/6
Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over	6hrs	0/6

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward	$V_f$	$I_F=\text{Typical Current}$		U.S.L x1.1
Luminous Flux	$I_m$	$I_F=\text{Typical Current}$	L.S.L x0.7	
CCX&CCY	x,y	$I_F=\text{Typical Current}$		Shift<0.02

### PRECAUTION FOR USE

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- (1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- (2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from ShineOn, a sealed container with a nitrogen atmosphere should be used for storage.
- (4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (5) The appearance and specifications of the product may be modified for improvement without notice.
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.
- (7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase ,turn-on voltage becomes lower and the LEDs get unlighted at low current.